

GENERAL PURPOSE AMPLIFIER

Pb-Free Product

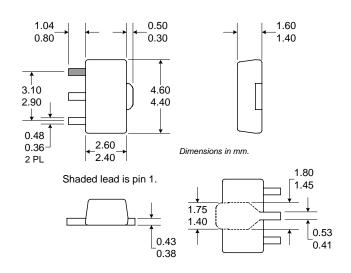
Typical Applications

- Basestation Applications
- Broadband, Low-Noise Gain Blocks
- IF or RF Buffer Amplifiers

- Driver Stage for Power Amplifiers
- Final PA for Low-Power Applications
- High Reliability Applications

Product Description

The RF3374 is a general purpose, low-cost RF amplifier IC. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as an easily-cascadable 50Ω gain block. Applications include IF and RF amplification in wireless voice and data communication products operating in frequency bands up to $6000\,\text{MHz}.$ The device is self-contained with 50Ω input and output impedances and requires only two external DC-biasing elements to operate as specified.



Optimum Technology Matching® Applied

- ☐ Si BJT ☐ GaAs MESFET☐ Si Bi-CMOS☐ SiGe HBT☐ Si CMOS☐ InGaP/HBT☐ GaN HEMT☐ SiGe Bi-CMOS☐
 - RF IN T GND GND TF OUT E

Functional Block Diagram

Package Style: SOT89

Features

- DC to >6000MHz Operation
- Internally Matched Input and Output
- 20dB Small Signal Gain
- +32dBm Output IP3
- +18dBm Output Power

Ordering Information

RF3374 General Purpose Amplifier RF3374PCBA-410 Fully Assembled Evaluation Board

RF Micro Devices, Inc. 7628 Thorndike Road Greensboro, NC 27409, USA Tel (336) 664 1233 Fax (336) 664 0454 http://www.rfmd.com

Absolute Maximum Ratings

Parameter	Rating	Unit
Input RF Power	+13	dBm
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-60 to +150	°C



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Parameter	Specification		Unit	Condition		
Farameter	Min.	Тур.	Max.	Offic	Condition	
Overall					T=25 °C, I _{CC} =65mA (See Note 1.)	
Frequency Range		DC to >6000		MHz		
3dB Bandwidth		3		GHz		
Gain	18.7	20.5		dB	Freq=500MHz	
	18.5	20.2	21.0	dB	Freq=1000MHz	
	17.0	18.9	22.0	dB	Freq=2000MHz	
		17.6		dB	Freq=3000MHz	
		16.2			Freq=4000MHz	
		13.5			Freq=6000MHz	
Noise Figure		3.5		dB	Freq=2000MHz	
Input VSWR		<1.5:1			In a 50Ω system, $500MHz$ to $3500MHz$	
		<2:1			In a 50Ω system, 3500MHz to 5000MHz	
Output VSWR		<1.6:1			In a 50Ω system, 500MHz to 3000MHz	
		<2:1			In a 50Ω system, 3000MHz to 5000MHz	
Output IP ₃	+29.0	+32.0		dBm	Freq=2000MHz	
Output P _{1dB}		+17.5		dBm	Freq=2000MHz	
Reverse Isolation		22.0		dB	Freq=2000MHz	
Thermal					I _{CC} =65mA, P _{DISS} =274mW. (See Note 3.)	
Theta _{JC}		170		°C/W	V _{PIN} =4.2V	
Maximum Measured Junction		132		°C	T _{CASE} =+85°C	
Temperature at DC Bias Con- ditions						
Mean Time To Failure		3050		years	T _{CASE} =+85°C	
Power Supply					With 22Ω bias resistor	
Device Operating Voltage		4.50	4.55	V	At pin 8 with I _{CC} =65mA at +25°C	
		5.95	6.30	V	At evaluation board connectors, I _{CC} =65mA	
Operating Current		65	80	mA	See Note 2.	

Note 1: All specification and characterization data has been gathered on standard FR-4 evaluation boards. These evaluation boards are not optimized for frequencies above 2.5GHz. Performance above 2.5GHz may improve if a high performance PCB is used.

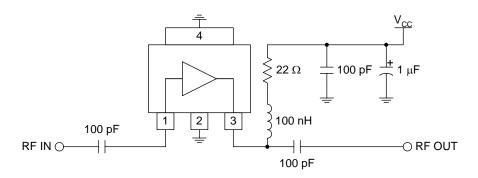
Note 2: The RF3374 must be operated at or below 80 mA in order to achieve the thermal performance listed above. While the RF3374 may be operated at higher bias currents, 65 mA is the recommended bias to ensure the highest possible reliability and electrical performance.

Note 3: Because of process variations from part to part, the current resulting from a fixed bias voltage will vary. As a result, caution should be used in designing fixed voltage bias circuits to ensure the worst case bias current does not exceed 80mA over all intended operating conditions.

4-584 Rev A7 050310

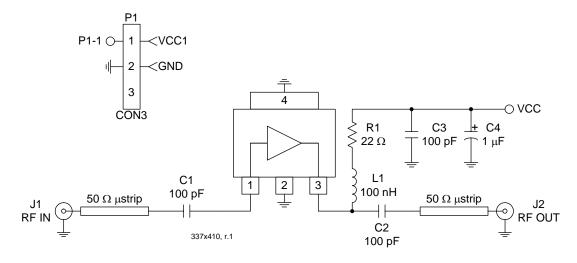
Pin	Function	Description	Interface Schematic
1	RF IN	RF input pin. This pin is NOT internally DC blocked. A DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability.	
2	GND	Ground connection.	
3	RF OUT	RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to $V_{\rm CC}$. The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation: $R = \frac{(V_{SUPPLY} - V_{DEVICE})}{I_{CC}}$ Because DC is present on this pin, a DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed. Care should also be taken in the resistor selection to ensure that the current into the part never exceeds 80 mA over the planned operating temperature.	RF IN O
4	GND	Ground connection.	

Application Schematic



Evaluation Board Schematic

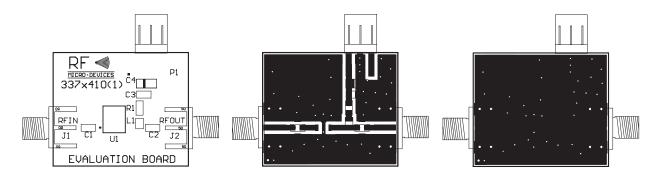
(Download Bill of Materials from www.rfmd.com.)

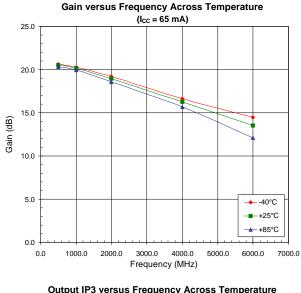


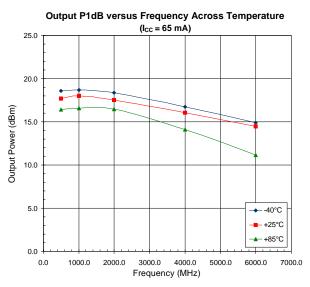
4-586 Rev A7 050310

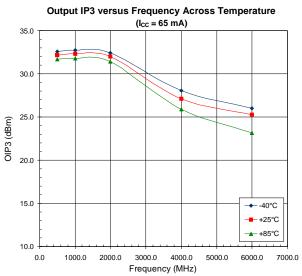
Evaluation Board Layout Board Size 1.195" x 1.000"

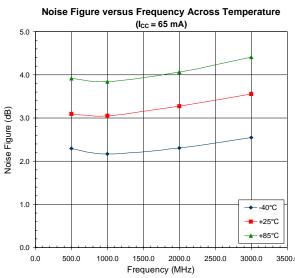
Board Thickness 0.033", Board Material FR-4

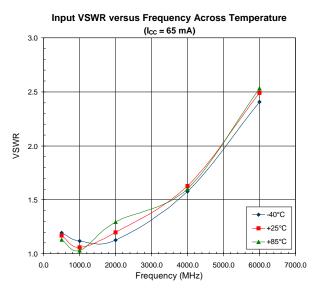


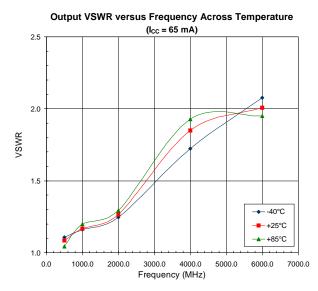




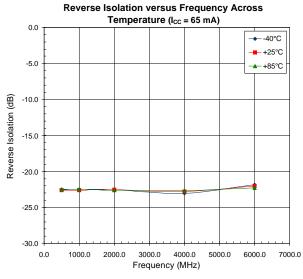


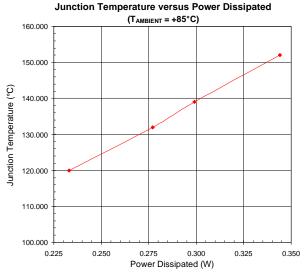


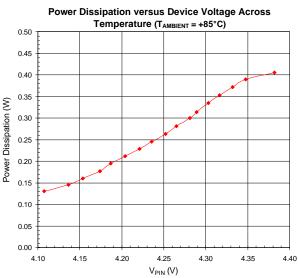


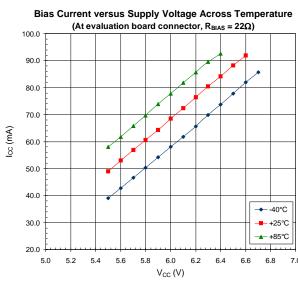


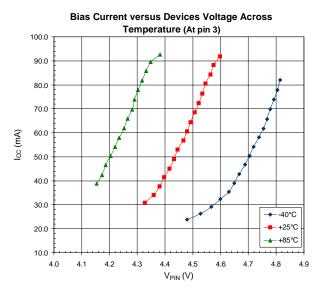
4-588 Rev A7 050310











4-590 Rev A7 050310